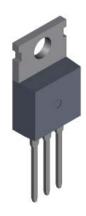


Triac (Bidirectional Triode Thyristor)

Features and Benefits

- Exceptional reliability
- Small SIP package with heatsink mounting for high thermal dissipation and long life
- V_{DRM} of 600 V
- 12 A_{RMS} on-state current
- Uniform switching

Package: 3-pin SIP (TO-220)



Description

This Sanken triac (bidirectional triode thyristor) is designed for AC power control, providing reliable, uniform switching for full-cycle AC applications.

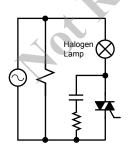
In comparison with other products on the market, the TMA126G-L provides greater peak nonrepetitive off-state voltage, V_{DSM} (700 V). In addition, commutation dv/dt and (dv/dt)c are improved.

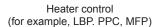
Applications

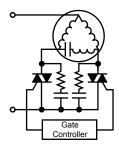
- Residential and commercial appliances: vacuum cleaners, rice cookers, TVs, home entertainment
- White goods: washing machines
- Office automation power control, photocopiers
- Motor control for small tools
- Temperature control, light dimmers, electric blankets
- General use switching mode power supplies (SMPS)

Not to scale

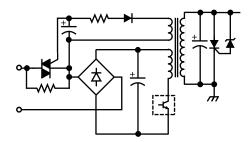
Typical Applications







Two-phase motor control (for example, washing machine)



In-rush current control (for example, SMPS)

TMA126G-L

Triac (Bidirectional Triode Thyristor)

Selection Guide

Part Number	Package	Packing	
TMA126G-L	3-pin fully molded SIP with heatsink mount	50 pieces per tube	

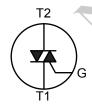
Absolute Maximum Ratings

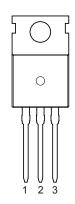
Characteristic	Symbol		Notes	Rating	Units
Peak Repetitive Off-State Voltage	V_{DRM}	R _{GREF} = ∞	•.0	600	V
Peak Non-Repetitive Off-State Voltage	V_{DSM}	R _{GREF} = ∞	R _{GREF} = ∞		V
RMS On-State Current	I _{T(RMS)}		50/60 Hz full cycle sine wave, total Conduction angle $(\alpha+)+(\alpha-)=360^{\circ}$, $T_C=103^{\circ}C$		А
Ourse On Otata Oursent	I _{TSM}	f = 60 Hz	Full cycle sine wave, peak value, non-repetitive, initial T _J = 25°C	126	Α
Surge On-State Current		f = 50 Hz		120	Α
I2t Value for Fusing	I²t	Value for 50 Hz half cycle sine wave, 1 cycle, I _{TSM} = 120 A		72	A ² •s
Critical Rising Rate of On-State Current	di/dt	$I_T = I_{T(RMS)} \times \sqrt{2}$, $V_D = V_{DRM} \times 0.5$, $f \le 60$ Hz, $t_{gw} \ge 10$ μs, $t_{gr} \le 250$ ns, $I_{gp} \ge 60$ mA (refer to Gate Trigger Current diagram)		25	A/µs
Peak Gate Current	I _{GM}	f ≥ 50 Hz, duty cycle ≤ 10%		2	Α
Peak Gate Power Dissipation	P_{GM}	f ≥ 50 Hz, duty cycle ≤ 10%		5	W
Average Gate Power Dissipation	P _{GM(AV)}			0.5	W
Junction Temperature	TJ	20		-40 to 125	°C
Storage Temperature	T _{stg}		Y	-40 to 125	°C

Thermal Characteristics May require derating at maximum conditions

Characteristic	Symbol	Test Conditions	Value	Units
Package Thermal Resistance (Junction to Case)	$R_{ heta JC}$	For AC	1.6	°C/W

Pin-out Diagram





Terminal List Table

Number	Name	Function
1	T1	Main terminal, gate referenced
2	T2	Main terminal connect to signal side
3	G	Gate control

All performance characteristics given are typical values for circuit or system baseline design only and are at the nominal operating voltage and an ambient temperature, T_A , of 25°C, unless otherwise stated.

TMA126G-L

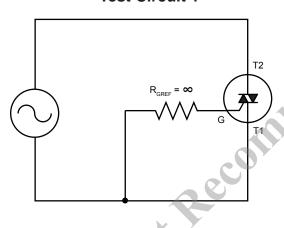
Triac (Bidirectional Triode Thyristor)

ELECTRICAL CHARACTERISTICS

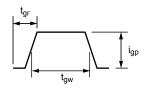
Characteristics	Symbol	Test Conditions		Min.	Тур.	Max.	Unit
Off-State Leakage Current	I _{DRM}	$V_D = V_{DRM}$, $T_J = 125^{\circ}C$, $R_{GREF} = \infty$ using test circuit 1		_	_	2.0	mA
Oil-State Leakage Current		$V_D = V_{DRM}$, $T_J = 25$ °C,	-	_	100	μΑ	
On-State Voltage	V _{TM}	I _T = 17 A, T _J = 25°C		-	-	1.5	V
	V_{GT}	Quadrant I: T2+, G+	V _D = 12 V, R _L = 20 Ω, T _J = 25°C	-	-	1.5	V
Gate Trigger Voltage		Quadrant II: T2+, G-		-	-	1.5	V
		Quadrant III: T2-, G-		-	-<	1.5	V
	I _{GT}	Quadrant I: T2+, G+	V_D = 12 V, R_L = 20 Ω , T_J = 25°C	-		30	mA
Gate Trigger Current		Quadrant II: T2+, G-		- (30	mA
		Quadrant III: T2-, G-		-0	? -	30	mA
Gate Non-trigger Voltage	V_{GD}	$V_D = V_{DRM} \times 0.5, R_L = 4$	0.2	_	_	V	
Critical Rising Rate of Off-State Voltage during Commutation*	(dv/dt)c	V _D = 400 V, (di/dt)c = -	10	_	-	V/µs	
Critical Rising Rate of Off-StateVoltage	dv/dt	$V_D = V_{DRM} \times 0.66$, R_{GRE}	200	_	_	V/µs	

^{*}Where I_{TP} is the peak current through T2 to T1.

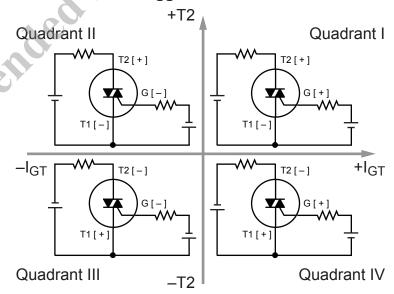
Test Circuit 1



Gate Trigger Current

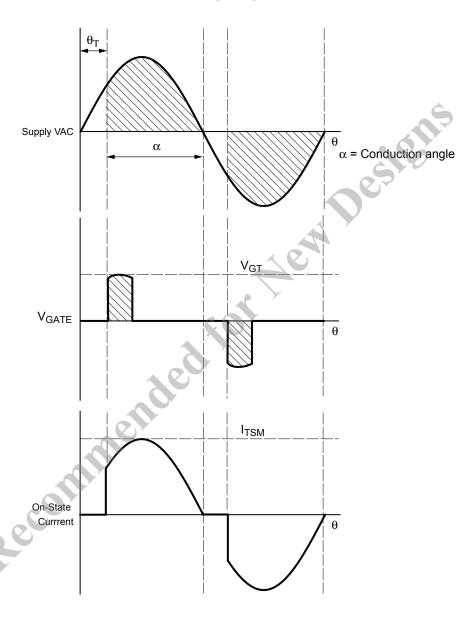


Gate Trigger Characteristics



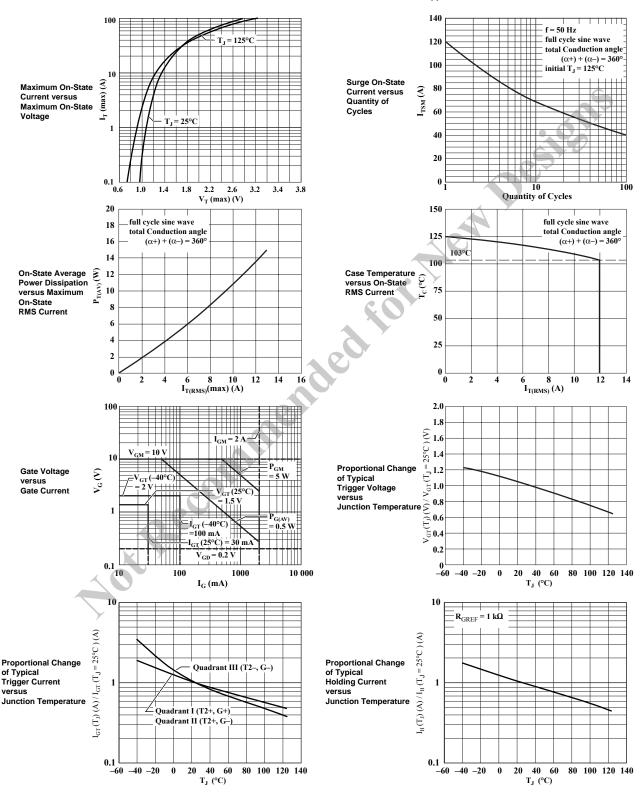
Polarities referenced to T1

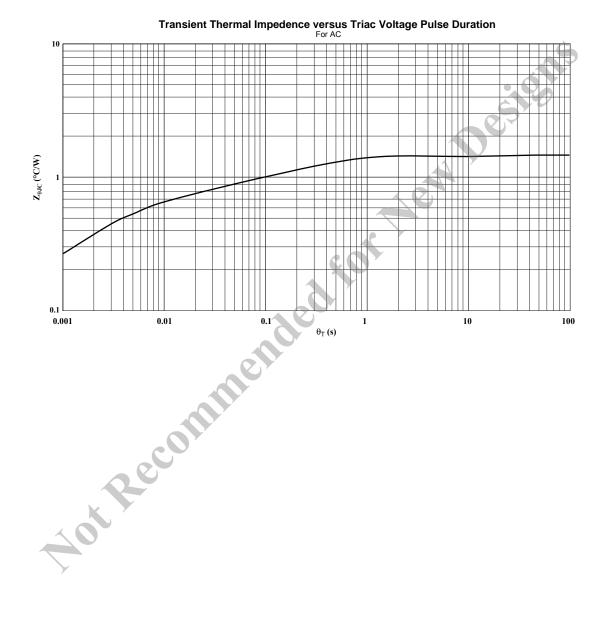
Commutation Timing Diagrams



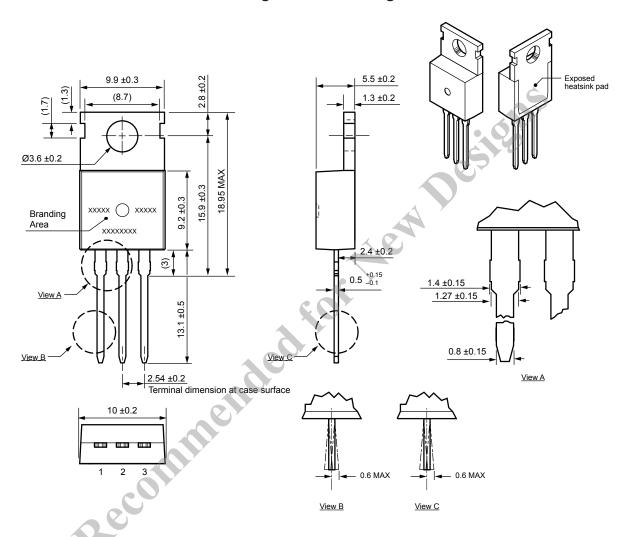
Triac (Bidirectional Triode Thyristor)

Performance Characteristics at T_A = 25°C





TO-220 Package Outline Drawing



Terminal core material: Cu Terminal treatment: Sn plating Package: TO-220

donago: 10 ==0

Dimensions in millimeters

Branding codes (exact appearance at manufacturer discretion): 1st line left, lot: YM

Where: Y is the last digit of the year of manufacture

M is the month (1 to 9, O, N, D)

1st line right, lot: DDR Where: DD is the date

R is a tracking letter

2nd line, type: MA126G



TMA126G-L

Triac (Bidirectional Triode Thyristor)

Because reliability can be affected adversely by improper storage environments and handling methods, please observe the following cautions.

Cautions for Storage

- Ensure that storage conditions comply with the standard temperature (5°C to 35°C) and the standard relative humidity (around 40% to 75%); avoid storage locations that experience extreme changes in temperature or humidity.
- Avoid locations where dust or harmful gases are present and avoid direct sunlight.
- Reinspect for rust on leads and solderability of the products that have been stored for a long time.

Cautions for Testing and Handling

When tests are carried out during inspection testing and other standard test periods, protect the products from power surges from the testing device, shorts between the product pins, and wrong connections. Ensure all test parameters are within the ratings specified by Sanken for the products.

Remarks About Using Silicone Grease with a Heatsink

- When silicone grease is used in mounting the products on a heatsink, it shall be applied evenly and thinly. If more silicone grease than required is applied, it may produce excess stress.
- Volatile-type silicone greases may crack after long periods of time, resulting in reduced heat radiation effect. Silicone greases with low consistency (hard grease) may cause cracks in the mold resin when screwing the products to a heatsink.

Our recommended silicone greases for heat radiation purposes, which will not cause any adverse effect on the product life, are indicated below:

Туре	Suppliers
G746	Shin-Etsu Chemical Co., Ltd.
YG6260	Momentive Performance Materials Inc.
SC102	Dow Corning Toray Co., Ltd.

Cautions for Mounting to a Heatsink

 When the flatness around the screw hole is insufficient, such as when mounting the products to a heatsink that has an extruded (burred) screw hole, the products can be damaged, even with a lower than recommended screw torque. For mounting the products, the mounting surface flatness should be 0.05 mm or less.

- Please select suitable screws for the product shape. Do not
 use a flat-head machine screw because of the stress to the
 products. Self-tapping screws are not recommended. When
 using self-tapping screws, the screw may enter the hole
 diagonally, not vertically, depending on the conditions of hole
 before threading or the work situation. That may stress the
 products and may cause failures.
- Recommended screw torque: 0.490 to 0.686 N

 m (5 to 7 kgf

 cm).
- For tightening screws, if a tightening tool (such as a driver) hits the products, the package may crack, and internal stress fractures may occur, which shorten the lifetime of the electrical elements and can cause catastrophic failure. Tightening with an air driver makes a substantial impact. In addition, a screw torque higher than the set torque can be applied and the package may be damaged. Therefore, an electric driver is recommended.

When the package is tightened at two or more places, first pre-tighten with a lower torque at all places, then tighten with the specified torque. When using a power driver, torque control is mandatory.

Soldering

- When soldering the products, please be sure to minimize the working time, within the following limits:
 - 260±5°C 10±1 s (Flow, 2 times) 380±10°C 3.5±0.5 s (Soldering iron, 1 time)
- Soldering should be at a distance of at least 1.5 mm from the body of the products.

Electrostatic Discharge

- When handling the products, the operator must be grounded. Grounded wrist straps worn should have at least 1 M Ω of resistance from the operator to ground to prevent shock hazard, and it should be placed near the operator.
- Workbenches where the products are handled should be grounded and be provided with conductive table and floor mats.
- When using measuring equipment such as a curve tracer, the equipment should be grounded.
- When soldering the products, the head of soldering irons
 or the solder bath must be grounded in order to prevent
 leak voltages generated by them from being applied to the
 products.
- The products should always be stored and transported in Sanken shipping containers or conductive containers, or be wrapped in aluminum foil.

